

# OCP ORv3 Rack Design

# AMAX ENGINEERING

With 40 years of engineering expertise, our team specializes in transforming standard IT components into high-performance computing solutions with optimized thermal, electrical, mechanical, and networking design.

## LiquidMax® RackScale 128

The LiquidMax® RackScale 128 is an ultra-high-density, fully liquid-cooled 51OU solution built on the OCP ORv3 architecture, delivering 128 GPUs for large-scale AI and ML workloads.

#### **Key Features**

- Supports up to 128x NVIDIA® Blackwell B200 GPUs or AMD Instinct™ MI300X / MI325X accelerators
- 8x OCP ORv3 5OU compute trays with cold plate liquid cooling
- Centralized 48V busbar power distribution for improved efficiency
- Built-in leakage detection, CDU support, and optional RDHx integration for thermal management

#### **Built for Hyperscale AI Infrastructure**

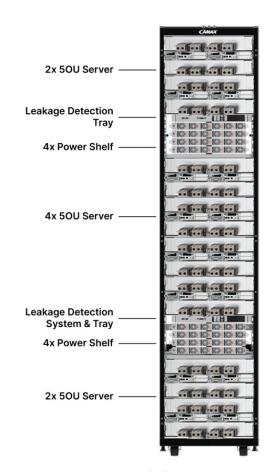
The RackScale 128 is designed for large-scale cloud providers, data centers, and enterprises with high-density compute needs. Its modular OCP ORv3 design supports 400W CPUs, 33kW power shelves, and cold plate liquid cooling, enabling efficient rack-level consolidation with reliable thermal and power delivery.



#### **Specifications**

LiquidMax® RackScale 128		
GPU	128x GPUs (8 x 50U compute trays)	
Cooling	Liquid-to-liquid cooling, CDU supported	
Architecture	OCP ORv3, 8× 50U compute trays	
Power	8 x 33kW shelves	
Management	Active leakage detection system with integrated trays	

50U Compute Tray	
Chassis	OCP ORv3 50U(2+1+2) Chassis, Cold-Plate Liquid Cooling for CPU and GPU
2 x 2U GPU Node	8 x NVIDIA HGX B200 OR AMD MI300X/MI325X
1U Compute Node	AMD Turin, SP5 (2-Socket ) support, Thermal Design Power (TDP) up to 400W
System Memory	<ul><li>24 x DDR5 DIMM slots; 1DPC</li><li>96GB DDR5 RDIMM (5600MT/s rated):</li></ul>
Expansion slots	6 x PCIe 5.0 x 16 (SS FHHL):  • 5 pcs ConnectX-7 or BCM957608-P1400GQF00 400Gb/s single port adapters  • 1 pcs Dual ports 10Gb NIC



LiquidMax® RackScale 128

#### **OCP ORv3 Architecture**

Built on the OCP ORv3 standard, the RackScale 128 leverages an open, modular design optimized for high-density deployments. The wider 21" rack format increases airflow efficiency, while front-to-back cooling and blind-mate liquid manifolds simplify integration and maintenance. The shared busbar architecture enables efficient 48V power distribution across compute nodes, reducing cable complexity and improving serviceability.



**50U Compute Tray** 

### Why AMAX

AMAX helps organizations deploy advanced computing infrastructure with confidence. From thermal and mechanical engineering to rack integration, testing, and deployment support, our team delivers reliable, high-performance solutions tailored to Al and high-density workloads. We work closely with customers to streamline implementation, optimize system performance, and support long-term success.

